

PAKCOOL® Thermally Conductive Encapsulant TPC-219-L

Key Features and Benefits

- Low viscosity, suitable for various potting modes
- 100% solids, no uncured by products
- Excellent high and low temperature, weather, radiation and exceptional dielectric properties
- Stable chemical and mechanical properties

Description

PAKCOOL® TPC-219-L is a high thermal conductivity, 1:1 two-part liquid electronic encapsulation material that cures at room temperature or with heat application. Beyond its high thermal conductivity, this product features low viscosity, excellent flowability, easy bubble release, low thermal expansion, and high insulation properties, all of which contribute to extending the lifespan of electronic components. It is extensively utilized for bonding heat-generating electronic components to heat sinks or metal casings. Before curing, TPC-219-L demonstrates superior flowability and levelness. It remains securely bonded within the protective casing through thermal cycling, ensuring a smooth surface finish without the release of any volatile compounds.

Applications

- **LED Assembly**
- **Inverters**
- **High-Frequency Transformers**
- **Power Modules**
- **Automotive Battery Packs**
- **Communication devices**
- **Electronic Components**

Storage Conditions

PAKCOOL® TPC-219-L should be stored in a cool, dry place.

Packaging Specifications

Available in 1Kg cans, 20Kg pails, and 40Kg pails. Custom packaging options are also available based on customer requirements.

Curing Time

PAKCOOL® TPC-219-L can be cure at room temperature for 12h-48h. The crosslinking time will be shortened with the increase of temperature (see table below).

25 °C	24 h
70 °C	40 min

Technical Parameters

Typical Properties	TPC-219-L	Test Methods
Base Material	Silicone	
Color	A: White B: Gray	Visual
Mix Ratio	1:1	
Viscosity (cP)	≤7000	ASTM D2196-15
Operation time (min @20 °C)	>20	
Thermal Conductivity (W/m·K)	1.9 ± 0.1	ASTM D5470
Hardness (Shore A)	45±5	ASTM D2240
Density (g/cm ³)	2.69±0.10	ASTM D792
Volume Resistivity (Ω·cm)	\geqslant 3.3 \times 10 ¹³	ASTM D257
Dielectric Strength (kV/mm)	≥16	ASTM D149
UL Flammability Rating	V-0	UL 94
Shelf Life (@ 20 °C)	12 months	-
Continuous Use Temperature (℃)	-50 ~ +200	

Note: Data is for guidance only and should not be used as product specifications.

Precautions

- This product may not solidify or completely solidify when exposed to some substances, such as sulfur, phosphorus, or nitrogen compounds and polysulfone, polysulfide, polyurethane, substances containing amides and amines, tin, arsenic, antimony, selenium, and tellurium, unsaturated hydrocarbons and plasticizers.
- During storage, it is normal for the fillers in the product to settle. Before use, thoroughly scrape and stir parts A and B within their respective containers to ensure a uniform mixture. Then, mix the components in a 1:1 ratio and continue stirring until the color is consistent throughout.

The data of this specification are obtained under laboratory conditions. However, because of the difference of use environment, process and so on, it can not guarantee the correctness and applicability of the product in some usage and use. When using, be sure to test to confirm the product suitable for your purpose. If you have any problems in using this product, please contact our technical department. We will do our best to help you.